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| <b>Notice of References Cited</b> |  | Application/Control No. | Applicant(s)/Patent Under Reexamination |             |
|                                   |  | 10/603,823              | TAKENAKA, SATOSHI                       |             |
| Examiner<br>Hsien-Ming Lee        |  | Art Unit<br>2823        |   | Page 1 of 1 |

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